



PATENT

(12)
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9/24/03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Farnworth et al.

Serial No.: 09/923,687

Filed: August 6, 2001

For: HERMETIC CHIP SIZE AND
METHOD OF MANUFACTURE

Examiner: F. Toledo

Group Art Unit: 2823

Attorney Docket No.: 2269-2741.5US
(95-0804.04/US)

CERTIFICATE OF MAILING

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June 17, 2003
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AMENDMENT UNDER 37 C.F.R. § 1.116

MAIL STOP AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This amendment is in response to the Final Office Action of May 21, 2003 whose initial period of response is set to expire on August 21, 2003.

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